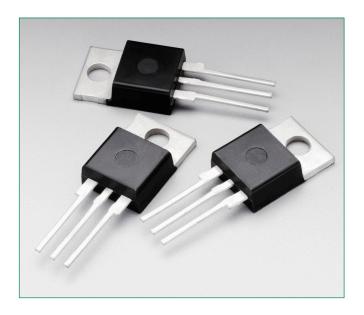
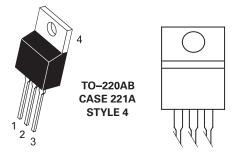


# 2N6344





#### **Pin Out**



#### **Description**

Designed primarily for full-wave AC control applications, such as light dimmers, motor controls, heating controls and power supplies; or wherever full-wave silicon gate controlled solid-state devices are needed. Triac type thyristors switch from a blocking to a conducting state for either polarity of applied anode voltage with positive or negative gate triggering.

#### **Features**

- Blocking Voltage to 800 V
- All Diffused and Glass Passivated Junctions for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Gate Triggering Guaranteed in all Four Quadrants
- For 400 Hz Operation, Consult Factory
- Pb-Free Package is Available

#### **Functional Diagram**



#### **Additional Information**







Samples



## Maximum Ratings and Thermal Characteristics (T<sub>1</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
*Peak Repetitive Off-State Voltage (Note 1) $(T_{\rm J}=-40~{\rm to}~110^{\rm o}{\rm C},~{\rm Sine~Wave},~50~{\rm to}~60~{\rm Hz},~{\rm Gate~Open})$ $2N6344$ $2N6349$	V <sub>DRM</sub> , V <sub>RRM</sub>	600 800	V
† On-State RMS Current ( $T_{\rm C} = +80^{\circ}{\rm C}$ ) Full Cycle Sine Wave 50 to 60 Hz ( $T_{\rm C} = +90^{\circ}{\rm C}$ )	I <sub>T (RMS)</sub>	8.0 4.0	А
† Peak Non–Repetitive Surge Current (One Full Cycle, Sine Wave 60 Hz, $T_{\rm C}$ = +25°C) Preceded and followed by rated current	I <sub>TSM</sub>	100	А
Circuit Fusing Considerations (t = 8.3 ms)	l <sub>2t</sub>	40	A <sup>2</sup> s
†Peak Gate Power ( $T_C = +80^{\circ}$ C, Pulse Width = 2 µs)	P <sub>GM</sub>	20	W
†Average Gate Power ( $T_c = +80^{\circ}$ C, t = 8.3 ms)	P <sub>G(AV)</sub>	0.5	W
†Peak Gate Current ( $T_c = +80^{\circ}$ C, Pulse Width = 2.0 µs)	I <sub>GM</sub>	2.0	А
†Peak Gate Voltage ( $T_c = +80^{\circ}\text{C}$ , Pulse Width = 2.0 µs)	$V_{GM}$	10	V
†Operating Junction Temperature Range	Т	-40 to +150	°C
Storage Temperature Range	T <sub>stg</sub>	-40 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### **Thermal Characteristics**

Rating	Symbol	Value	Unit
† Thermal Resistance, Junction to Case	R <sub>sJC</sub>	2.2	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	T <sub>L</sub>	260	°C

<sup>†</sup> Indicates JEDEC Registered Data.

<sup>†</sup> Indicates JEDEC Registered Data.

<sup>1.</sup> V<sub>DBM</sub> and V<sub>RBM</sub> for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



## **Electrical Characteristics** - **OFF** ( $T_c = 25^{\circ}$ C unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
*Peak Repetitive Blocking Current	$T_{_{\rm J}}=25^{\circ}{\rm C}$	I <sub>DRM</sub> ,	-	-	1.0	μΑ
$(V_D = V_{DRM} = V_{RRM}; Gate Open)$	T <sub>J</sub> = 100°C	I <sub>RRM</sub>	-	-	2.0	mA

## Electrical Characteristics - ON $(T_c = 25^{\circ}\text{C unless otherwise noted}; \text{ Electricals apply in both directions})$

Characteristic		Symbol	Min	Тур	Max	Unit
†Peak On–State Voltage ( $I_{TM} = \pm 11$ A Peak; Pulse Width = 1 to 2 ms, Duty Cycle $\leq$ 2%)			-	1.3	1.55	V
Gate Trigger Current (Continuous dc) ( $V_D = 12 \text{ Vdc}$ , $R_L = 100 \Omega$ )						
Quadrant I: MT2(+), G(+)	Both		-	12	50	
Quadrant II: MT2(+), G(–)	2N6349		-	12	75	
Quadrant III: MT2(-), G(-)	Both		-	20	50	, no 1
Quadrant IV: MT2(-), G(+)	2N6349	GT	-	35	75	mA
$^{\dagger}MT2(+), G(+); MT2(-), G(-)TC = -40^{\circ}C$	-		-	-	100	
$\dagger MT2(+), G(-); MT2(-), G(+)TC = -40^{\circ}C$	-		-	-	125	
Gate Trigger Voltage (Continuous dc) ( $V_D = 12 \text{ Vdc}$ , $R_L = 100 \Omega$ )						
Quadrant I: MT2(+), G(+)	Both		-	С	2.0	
Quadrant II: MT2(+), G(–)	2N6349		-		2.5	
Quadrant III: MT2(-), G(-)	Both		-		2.0	V
Quadrant IV: MT2(-), G(+)	2N6349	V <sub>GT</sub>	-		2.5	V
$^{\dagger}MT2(+), G(+); MT2(-), G(-)TC = -40^{\circ}C$	-		-		2.5	
$^{\dagger}MT2(+), G(-); MT2(-), G(+)TC = -40^{\circ}C$	-		-		3.0	
Gate Non-Trigger Voltage (Continuous dc) $(V_D = Rated V_{DRM}, R_L = 10 k \Omega, T_J = 100^{\circ}C)$		V <sub>GD</sub>	.02	-	-	V
†MT2(+), G(+); MT2(-), G(-); MT2(+), G(-); MT2(-), G(-)	TC = 25°C		-	6.0	40	m^
	TC = -40°C	I <sub>H</sub>	-	-	75	mA
†Turn-On Time ( $V_D$ = Rated $V_{DRM'}$ $I_{TM}$ = 11 A, $IG_T$ = 120 mA, Rise Time = 0.1 $\mu$ s, Pulse Width = 2 $\mu$ s)		t <sub>gt</sub>	-	1.5	2.0	μs

†Indicates JEDEC Registered Data.

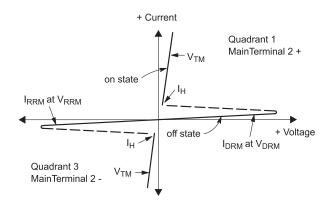
## **Dynamic Characteristics**

Characteristic	Symbol	Min	Тур	Max	Unit
Critical Rate of Rise of Commutation Voltag ( $V_D$ = Rated $V_{DRM}$ , $I_{TM}$ = 11 A, Commutating di/dt = 4.0 A/ms, Gate Unenergized, TC = 80°C)	dv/dt(c)	_	5.0	_	V/µs

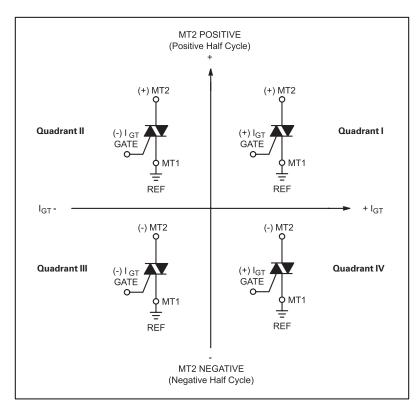


## Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter	
$V_{DRM}$	Peak Repetitive Forward Off State Voltage	
I <sub>DRM</sub>	Peak Forward Blocking Current	
V <sub>RRM</sub>	Peak Repetitive Reverse Off State Voltage	
I <sub>RRM</sub>	Peak Reverse Blocking Current	
V <sub>TM</sub>	Maximum On State Voltage	
I <sub>H</sub>	Holding Current	



## **Quadrant Definitions for a Triac**



All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.

**Thyristors** 



## **Ratings and Characteristic Curves**

## **Figure 1. RMS Current Derating**

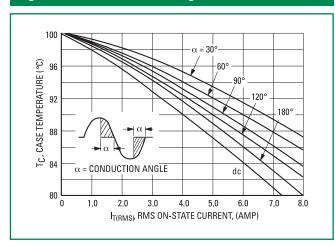


Figure 2. On-State Power Dissipation

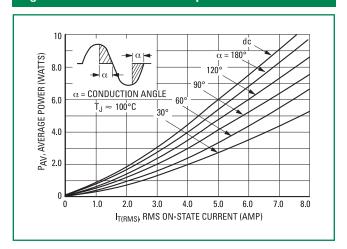


Figure 3. Typical Gate Trigger Voltage

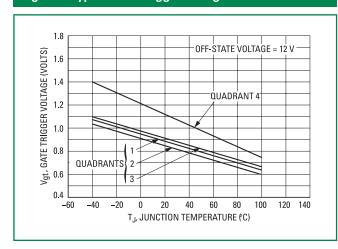
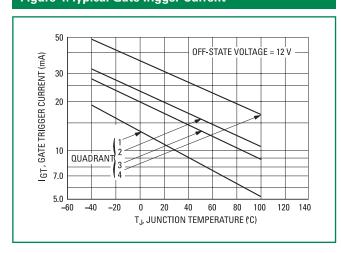


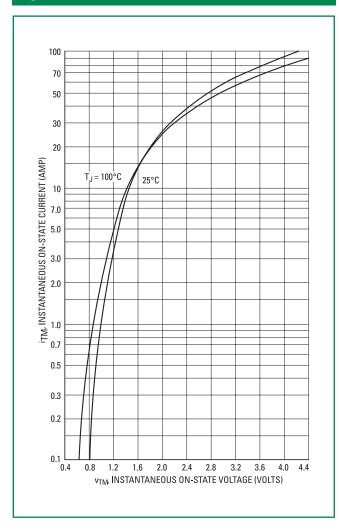
Figure 4. Typical Gate Trigger Current



**Thyristors** 



## Figure 7. Maximum On-State Characteristics



**Figure 8. Typical Holding Current** 

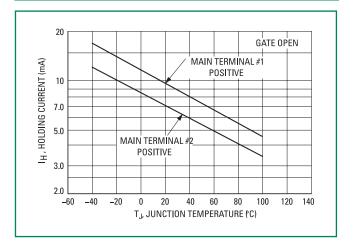


Figure 9. Maximum Allowable Surge Current

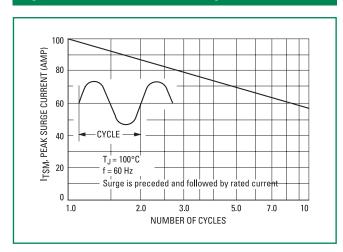
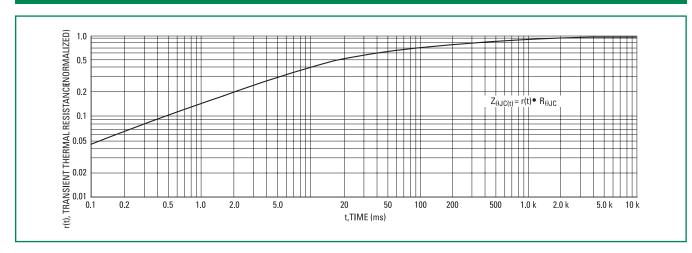
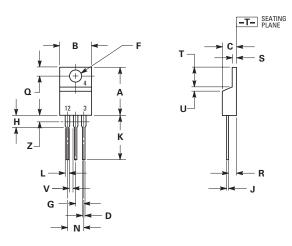


Figure 10. Thermal Response





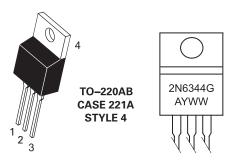
#### **Dimensions**



	Inches		Millim	neters	
Dim	Min	Max	Min	Max	
А	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.035	0.64	0.88	
F	0.142	0.147	3.61	3.73	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.155	2.80	3.93	
J	0.014	0.022	0.36	0.55	
K	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
N	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
V	0.045		1.15		
Z		0.080		2.04	

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

## **Part Marking System**



A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

Pin Assignment	
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

## **Ordering Information**

Device	Package	Shipping†
2N6344	TO-220AB	
2N6344G	TO-220AB (Pb-Free)	500 Units / Box

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